



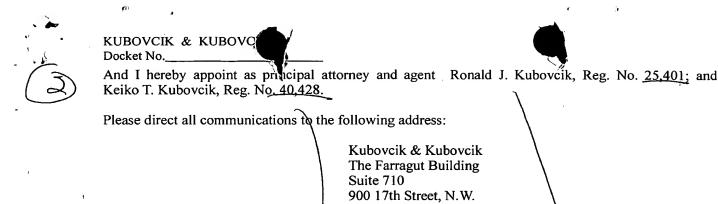


 $20374 \\ {}_{\text{PATENT_TRADEMARK OFFICE}}$

Declaration For U.S. Patent Application

As a below named inventor, I hereby declare that:

I believe I first and	am the orig joint inve nd for which	inal, first and sont ntor (if plural	ole inventor (i names are li	s stated below next to f only one name is I sted below) of the ntion entitled (INSE	isted below) or an original, subject matter which is			
the specifica	ation of whi	ch			,			
(Check one of 1, 2, or 3.)		is attached here was filed on Market International PC and was amende	March 27, 200 CT Application) No. PCT/JP00/0185 (if applicable)	_ as 59			
	3	was filed on _			as			
		U.S. Application and was amende			· · · · · · · · · · · · · · · · · · ·			
		and was amond		(if applicable)	•			
I hereby state that I have reviewed and understand the content of the above-identified specification, including the claim(s), as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to the patentability of this application as defined in Title 37, Code of Federal Regulations, § 1.56. I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for								
which priori	ty is claimed	d:						
(List prior foreign					Priority Claimed			
applications.)	(Number)	(Country)	(Day/Mo	nth/Year Filed)	Yes No			
	(Number)	(Country)	(Day/Mo	nth/Year Filed)	Yes No			
				<u> </u>	Yes No			
	(Number)	(Country)	(Day/Mo	nth/Year Filed)				
See attached list for additional prior foreign applications								
application I not disclose Title 35, Un defined in T	listed below d in the pride in the pride ited States itle 37, Cod	and, insofar as or United States Code, § 112, I le of Federal Re	the subject m application in acknowledge gulations, §	atter of each of the c the manner provide the duty to disclose	f any United States patent claims of this application is d by the first paragraph of se material information as between the filing date of application:			
	(Application	on Serial No.)	(Filing Date)	(Status)	_			



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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Inventor's Signature: Residence: Kan Citizenship: Japa Post Office Address:	agawa, Japan	TD., 5-13-1, Shu		nra, Tama-ku,
Full name of second in Inventor's Signature: Residence:	nventor:			
Citizenship: Post Office Address:				
Full name of third involutions of third involutions of third involutions of the state of the sta	entor:		_Data: _	
Citizenship: Post Office Address:				